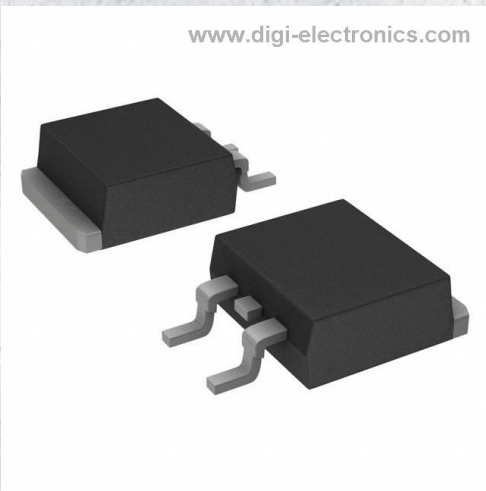
IRFW540ATM Datasheet



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DiGi Electronics Part Number	IRFW540ATM-DG
Manufacturer	onsemi
Manufacturer Product Number	IRFW540ATM
Description	MOSFET N-CH 100V 28A D2PAK
Detailed Description	N-Channel 100 V 28A (Tc) 3.8W (Ta), 107W (Tc) Surface Mount TO-263 (D2PAK)

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRFW540ATM	onsemi
Series:	Product Status:
-	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
100 V	28A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	52mOhm @ 14A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250µA	78 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1710 pF @ 25 V
FET Feature:	Power Dissipation (Max):
-	3.8W (Ta), 107W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 175°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
TO-263 (D2PAK)	TO-263-3, D2PAK (2 Leads + Tab), TO-263AB
Base Product Number:	
IRFW5	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.29.0095

Advanced Power MOSFET

IRFW/I540A

FEATURES

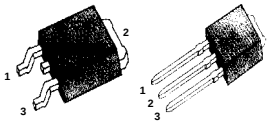
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- 175℃ Operating Temperature
- Lower Leakage Current : 10 μA (Max.) @ V_{DS} = 100V
- Lower $R_{DS(ON)}$: 0.041 Ω (Typ.)

BV_{DSS} = 100 V

$R_{DS(on)}$ = 0.052 Ω

I_D = 28 A

D^2-PAK **I^2-PAK**



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	100	V
I_D	Continuous Drain Current (T_C=25℃)	28	A
	Continuous Drain Current (T_C=100℃)	19.8	
I_{DM}	Drain Current-Pulsed ①	110	A
V_{GS}	Gate-to-Source Voltage	±20	V
E_{AS}	Single Pulsed Avalanche Energy ②	523	mJ
I_{AR}	Avalanche Current ①	28	A
E_{AR}	Repetitive Avalanche Energy ①	10.7	mJ
dv/dt	Peak Diode Recovery dv/dt ③	6.5	V/ns
P_D	Total Power Dissipation (T_A=25℃) *	3.8	W
	Total Power Dissipation (T_C=25℃)	107	W
	Linear Derating Factor	0.71	W/℃
T_J , T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	℃
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8? from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	1.4	℃/W
$R_{\theta JA}$	Junction-to-Ambient *	--	40	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

* When mounted on the minimum pad size recommended (PCB Mount).

Rev. B1

FAIRCHILD SEMICONDUCTOR®

IRFW/I540A

N-CHANNEL POWER MOSFET

Electrical Characteristics (T_C=25℃ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	100	--	--	V	V_{GS}=0V,I_D=250μA
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.11	--	V/℃	I_D=250μA ***See Fig 7***
$V_{GS(th)}$	Gate Threshold Voltage	2.0	--	4.0	V	V_{DS}=5V,I_D=250μA
I_{GSS}	Gate-Source Leakage , Forward	--	--	100	nA	V_{GS}=20V
	Gate-Source Leakage , Reverse	--	--	-100		V_{GS}=-20V
I_{DSS}	Drain-to-Source Leakage Current	--	--	10	μA	V_{DS}=100V
		--	--	100		V_{DS}=80V,T_C=150℃
$R_{DS(on)}$	Static Drain-Source On-State Resistance	--	--	0.052	Ω	V_{GS}=10V,I_D=14A ④
g_{FS}	Forward Transconductance	--	22.56	--	S	V_{DS}=40V,I_D=14A ④
C_{iss}	Input Capacitance	--	1320	1710	pF	V_{GS}=0V,V_{DS}=25V,f =1MHz ***See Fig 5***
C_{oss}	Output Capacitance	--	325	380		
C_{rss}	Reverse Transfer Capacitance	--	148	170		
$t_{d(on)}$	Turn-On Delay Time	--	18	50	ns	V_{DD}=50V,I_D=28A, R_G=9.1Ω ***See Fig 13*** ④ ⑤
t_r	Rise Time	--	18	50		
$t_{d(off)}$	Turn-Off Delay Time	--	90	180		
t_f	Fall Time	--	56	120		
Q_g	Total Gate Charge	--	60	78	nC	V_{DS}=80V,V_{GS}=10V, I_D=28A ***See Fig 6 & Fig 12*** ④ ⑤
Q_{gs}	Gate-Source Charge	--	10.8	--		
Q_{gd}	Gate-Drain(밭iller? Charge	--	27.9	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	28	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	110		
V_{SD}	Diode Forward Voltage ④	--	--	1.5	V	T_J=25℃,I_S=28A,V_{GS}=0V
t_{rr}	Reverse Recovery Time	--	132	--	ns	T_J=25℃,I_F=28A di_F/dt=100A/μs ④
Q_{rr}	Reverse Recovery Charge	--	0.63	--	μC	

Notes ;

① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature

② L=1mH, I_{AS}=28A, V_{DD}=25V, R_G=27Ω, Starting T_J=25℃

③ I_{SD}≤28A, di/dt≤400A/μs, V_{DD}≤BV_{DSS}, Starting T_J=25℃

④ Pulse Test : Pulse Width = 250μs, Duty Cycle ≤ 2%

⑤ Essentially Independent of Operating Temperature

FAIRCHILD SEMICONDUCTOR®

Fig 1. Output Characteristics

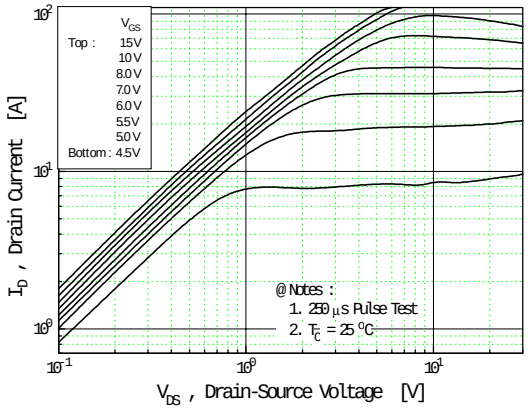


Fig 2. Transfer Characteristics

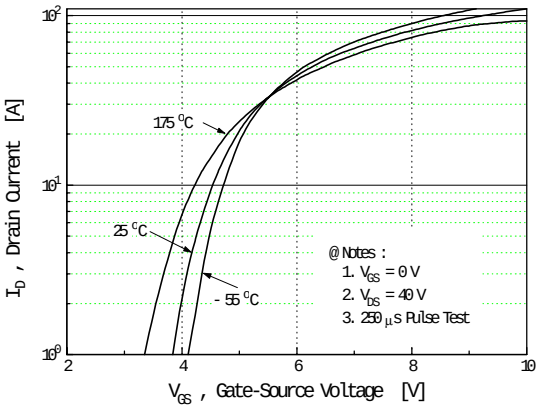


Fig 3. On-Resistance vs. Drain Current

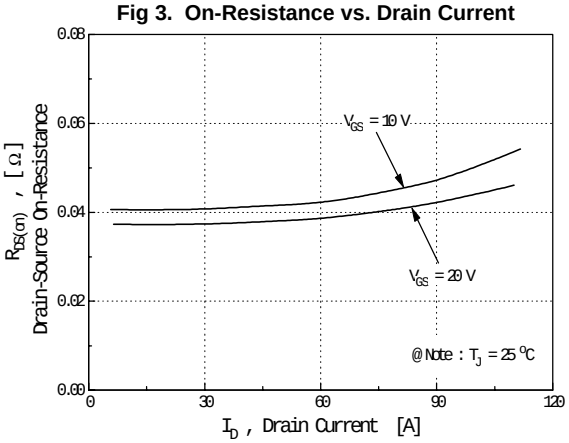


Fig 4. Source-Drain Diode Forward Voltage

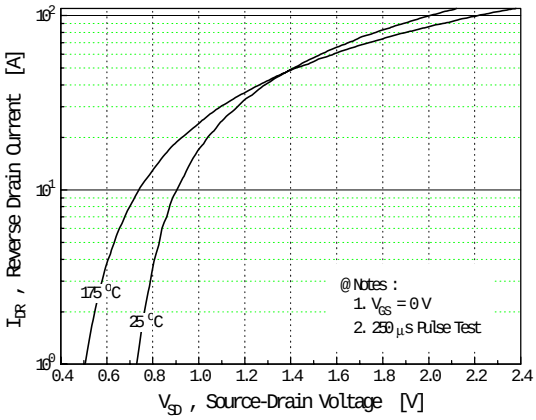


Fig 5. Capacitance vs. Drain-Source Voltage

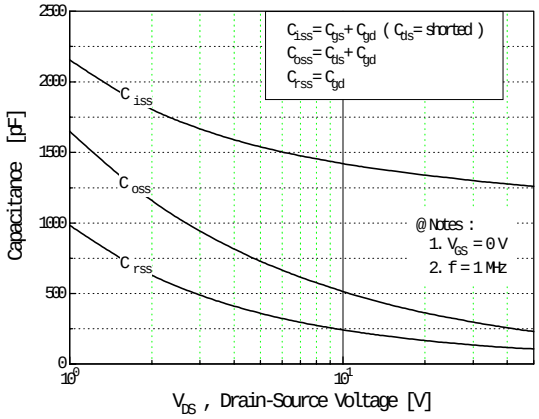


Fig 6. Gate Charge vs. Gate-Source Voltage

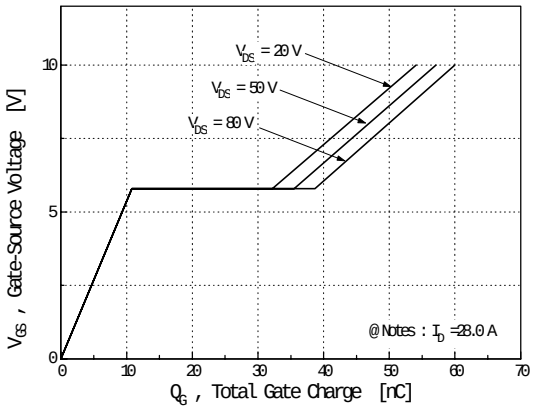


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Fig 7. Breakdown Voltage vs. Temperature

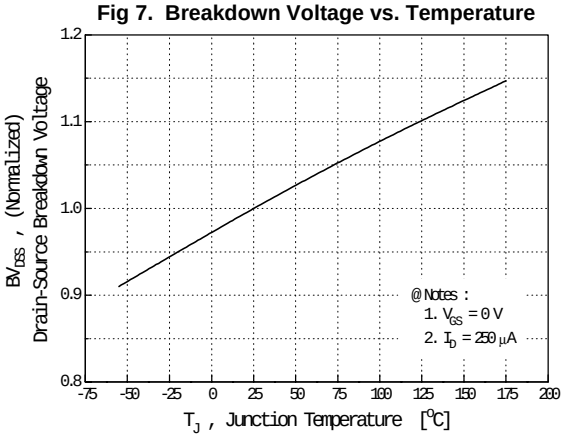


Fig 8. On-Resistance vs. Temperature

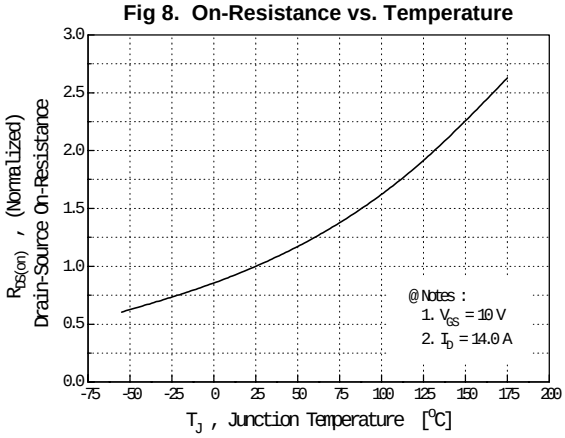


Fig 9. Max. Safe Operating Area

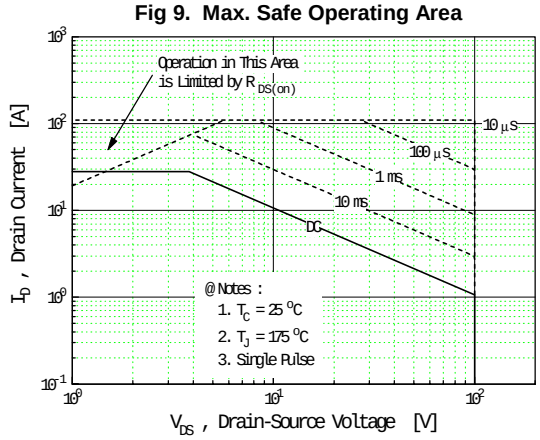


Fig 10. Max. Drain Current vs. Case Temperature

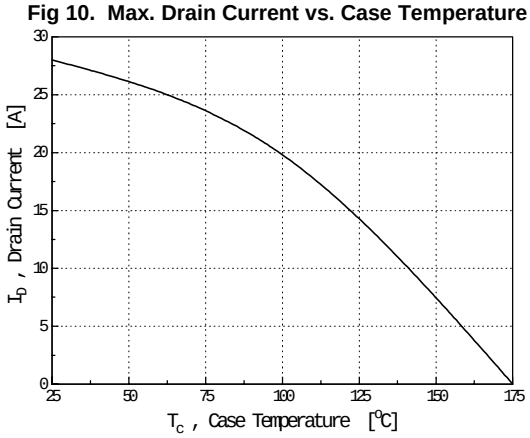


Fig 11. Thermal Response

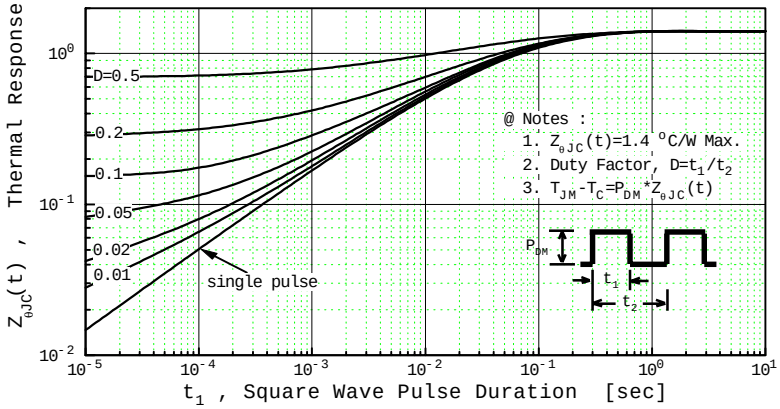


Fig 12. Gate Charge Test Circuit & Waveform

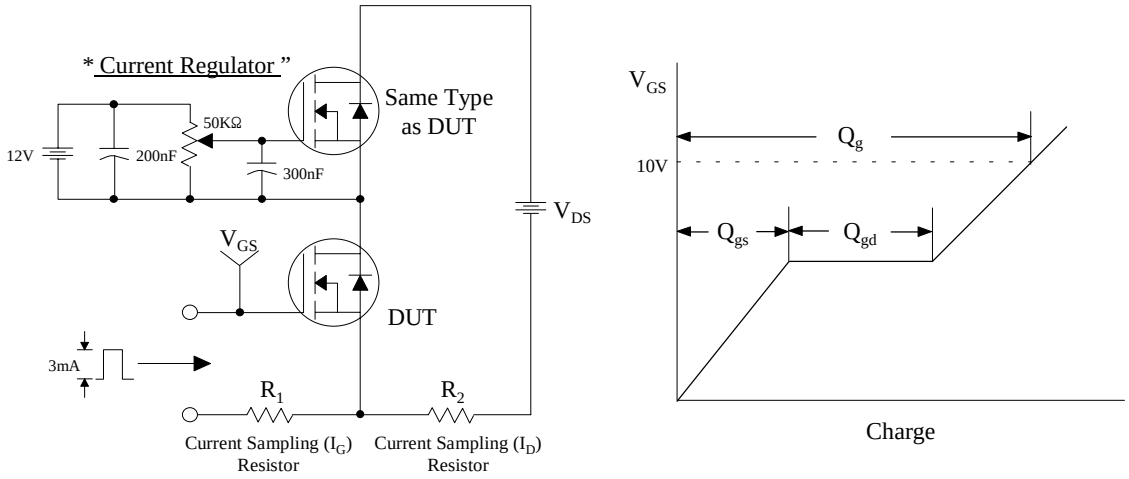


Fig 13. Resistive Switching Test Circuit & Waveforms

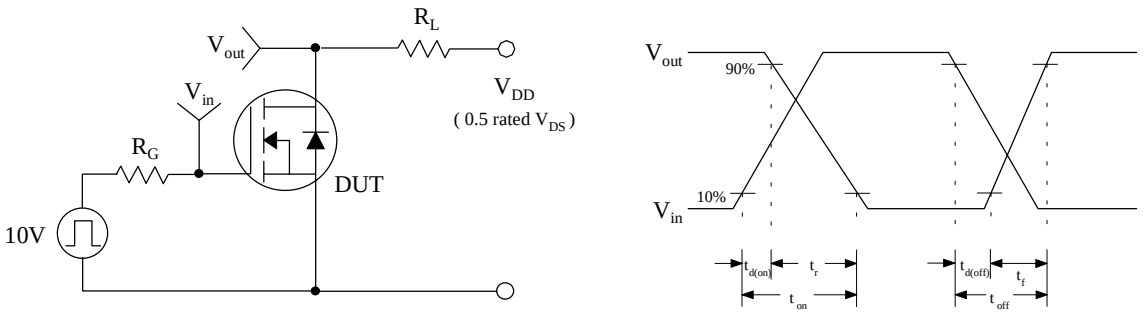


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

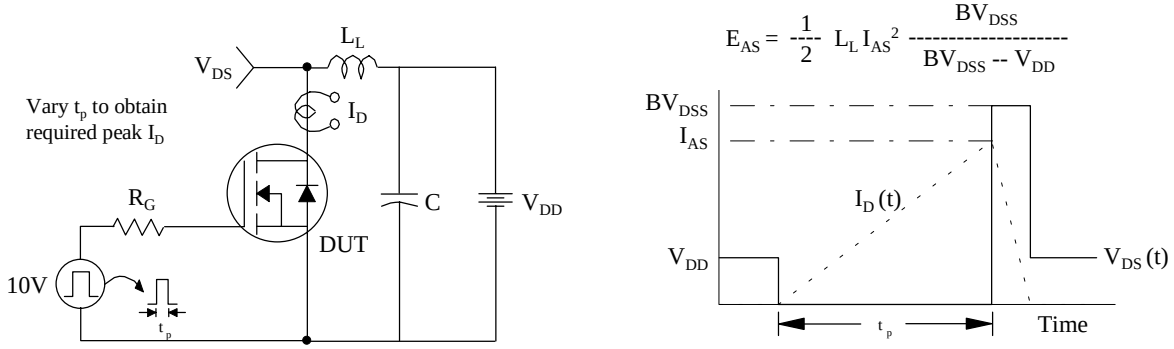
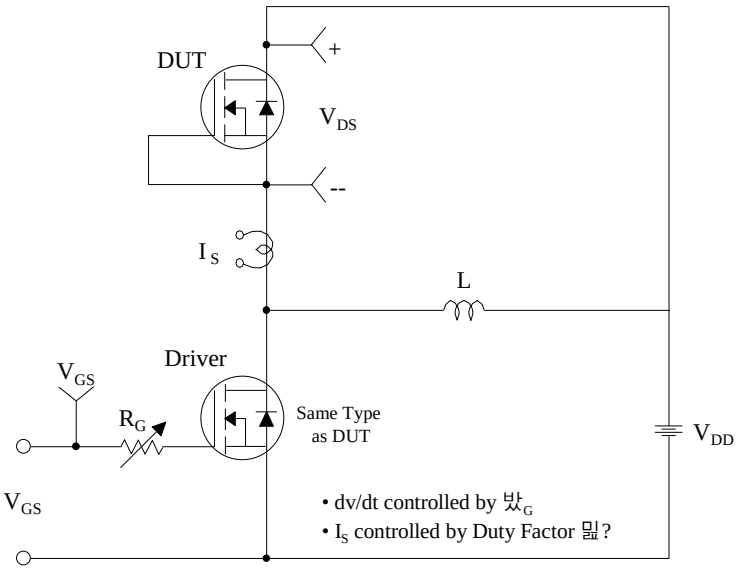
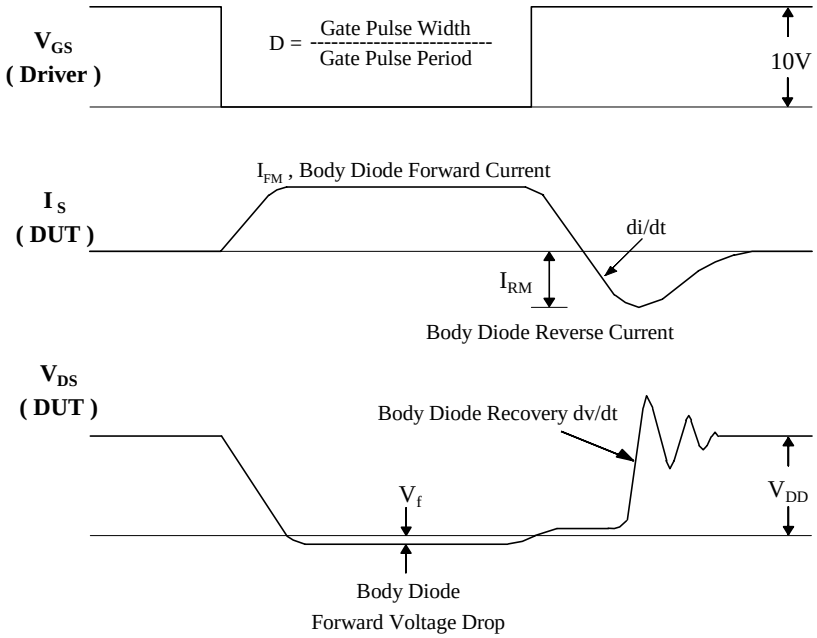


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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Rev. H4

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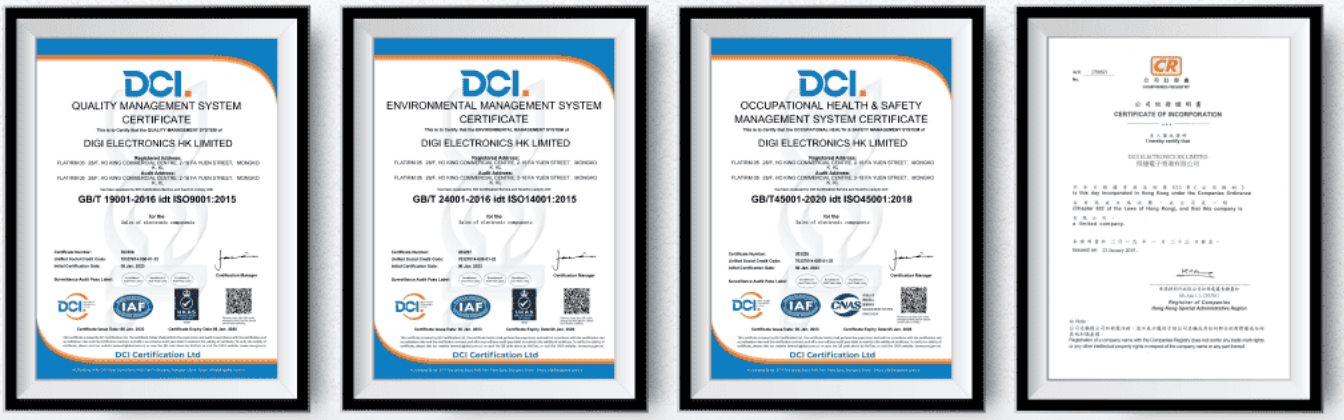

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